

07-24-1998



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Robert W. Batz, Jr.; Kenneth C. Haugan;  
Harry J. Geyer; Robert W. BernerAdditional name(s) of conveying  
party(ies) attached? ☐ Yes ☒ No

## 3. Nature of conveyance:

- ☒ Assignment ☐ Security Agreement  
☐ Merger ☐ Change of Name  
☐ Other

Execution Date June 9, 1998

## 2. Name and address of receiving party(ies):

Name Semitool, Inc.

Internal Address:

Street Address: P. O. Box 7010City: Kalispell State: MT Zip: 59904Additional names(s) & address(es) attached: ☐ Yes ☒ No

## 4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is

A. Patent Application No.(s):  
08/940,685

B. Patent No.(s):

Additional numbers attached: ☐ Yes ☒ NoAdditional numbers attached: ☐ Yes ☒ No5. Name and address of party to whom  
correspondence concerning document should be  
mailed:Name: Randy A. Gregory

Internal Address:

Wells, St. John, RobertsGregory & Matkin P.S.Street Address: 601 W. First Avenue, Ste. 1300City: Spokane State: WA Zip: 99201-38176. Total number of applications and  
patents involved: 17. Total fee (37 CFR 3.41): \$ 40.00☒ Enclosed

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Signature

Date

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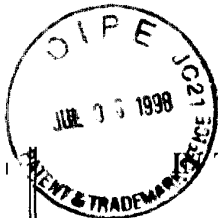
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PATENT

REEL: 9329 FRAME: 0957



1 THE UNITED STATES PATENT AND TRADEMARK OFFICE

2 Application Serial No. . . . . 08/940,685  
3 Filing Date . . . . . September 30, 1997  
4 Inventor . . . . . Batz et al.  
5 Assignee . . . . . Semitool, Inc.  
6 Group Art Unit . . . . . Unknown  
7 Examiner . . . . . Unknown  
8 Attorney's Docket No. . . . . SE10-0125  
9 Title: Methods For Plating Semiconductor Workpieces Using A Workpiece-Engaging  
10 Electrode Assembly With Sealing Boot

7 ASSIGNMENT

8 PARTIES TO THE ASSIGNMENT:

9 INVENTORS:

10 Robert W. Batz, Jr.  
11 P.O. Box 7010  
12 Kalispell, MT 59904

12 Kenneth C. Haugan  
13 P.O. Box 7010  
14 Kalispell, MT 59904

14 Harry J. Geyer  
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16 Kalispell, MT 59904

16 Robert W. Berner  
17 P.O. Box 7010  
18 Kalispell, MT 59904

18 ASSIGNEE:

19 Semitool, Inc.  
20 Corporation of the State of Montana  
21 P.O. Box 7010  
22 Kalispell, MT 59904

22 BACKGROUND OF THIS ASSIGNMENT:

23 Inventors have conceived certain new and useful inventions  
24 disclosed in a United States Patent Application Serial No. 08/940,685.

1 filed September 30, 1997, and titled Methods For Plating Semiconductor  
2 Workpieces Using A Workpiece-Engaging Electrode Assembly With  
3 Sealing Boot.

4 Semitool, Inc. desires to acquire the entire right, title and interest  
5 in said inventions and with respect to any Letters Patent that may be  
6 granted with respect to the inventions in both the United States and in  
7 all foreign countries.

8 **THE PARTIES AGREE AS FOLLOWS:**

9 In consideration of good and valuable consideration, the receipt of  
10 which is hereby acknowledged, INVENTORS have sold, assigned and  
11 transferred to Semitool, Inc. the full and exclusive right to said  
12 inventions in the United States and in all foreign countries.

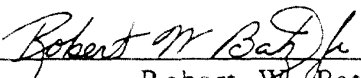
13 INVENTORS do hereby sell, assign and transfer to Semitool, Inc.  
14 the entire right, title and interest in the above-identified application and  
15 to any reissues, divisions or continuations thereof, and hereby authorizes  
16 the Commissioner of Patents and Trademarks to issue such Letters  
17 Patent to Semitool, Inc. for the sole use of Semitool, Inc., its successors  
18 or assigns.

19 INVENTORS further agree to execute, at the request and expense  
20 of Semitool, Inc. such other formal documents as may be required to  
21 fully convey the interest transferred herein and will similarly execute any  
22 applications papers required for the filing of any division, continuation  
23 or reissue of the patent application or resulting Letters Patent; and will  
24

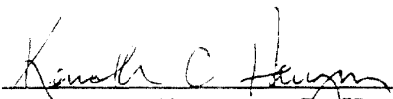
1 generally do everything necessary or desirable to obtain and enforce  
2 proper protection for the inventions assigned hereby.

3 INVENTORS further assign to Semitool, Inc. the whole right, title  
4 and interest in the inventions disclosed in the application throughout all  
5 countries foreign to the United States. Semitool, Inc. is hereby  
6 authorized to apply for patents relating to the inventions in its own  
7 name in countries where such procedure is proper; to claim the benefit  
8 of the International Convention; to file and prosecute International  
9 Applications relating to the inventions under the Patent Cooperation  
10 Treaty; and to file and prosecute applications relating to the inventions  
11 under the European Patent Convention. INVENTORS agree to execute  
12 applications relating to the inventions in those countries and under those  
13 conventions where it is necessary that the same be executed by the  
14 inventor, and to execute assignments of such applications and the  
15 resulting Letters Patent to Semitool, Inc. as well as all other necessary  
16 papers in relation to such applications and Letters Patent.

17  
18 Dated: 3/23/98

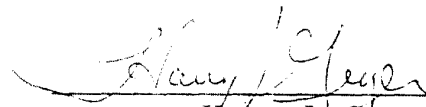
  
Robert W. Batz, Jr.

19  
20 Dated: 3/26/98


  
Kenneth C. Haugan

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Dated: 4/2/98

  
Harry J. Geyer

Dated: 6/9/98

  
Robert W. Berner